

SURFBOARDS®

THE BREADBOARDING MEDIUM FOR **SURFACE MOUNT**™



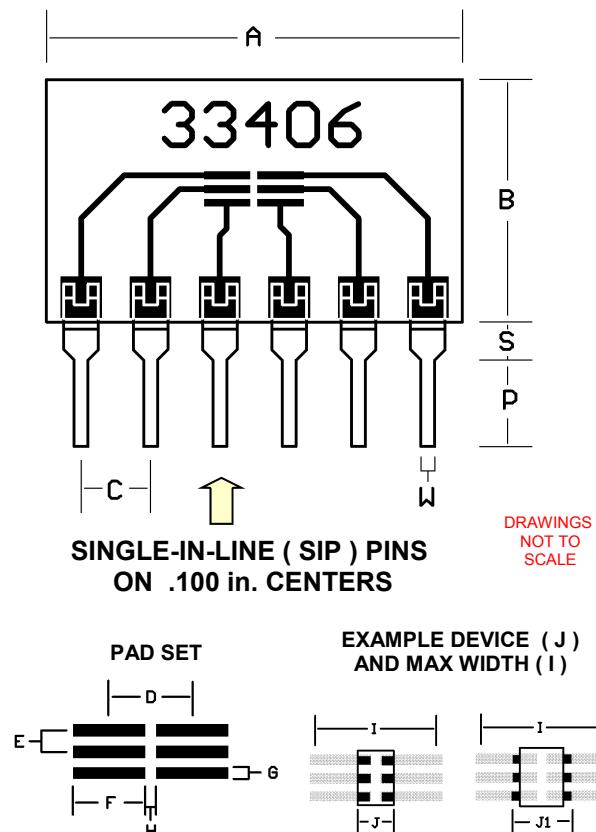
33000 SERIES APPLICATION SPECIFIC ADAPTERS

IDS33406
REV A- 10-2011

MODEL 33406

6 LEAD .5 mm PITCH DEVICES

DEVICE LEAD WIDTHS 1.0, 1.5, 1.6, 1.65, To Max 3.3



MOUNTING PADS ARE OVERSIZED IN LENGTH TO
ACCEPT A WIDER RANGE OF DEVICE WIDTHS AND
TOLERANCES AND TO PERMIT HAND SOLDERING.

SEE WEBSITE FOR SOLDERING SUGGESTIONS

ES-2002-E

CAPITAL ADVANCED TECHNOLOGIES, INC.

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MADE
IN
USA

FIG.	MM	IN.	NOTE:
A	15.24	.600	BOARD WIDTH $\pm .5\text{mm}$.020in.
B	8.89	.350	BOARD HEIGHT $\pm .5\text{mm}$.020in.
C	2.54	.100	SIP PIN SPACE $\pm .20\text{mm}$.008in.
D	1.95	.077	PAD CENTERLINE
E	.5	.020	DEVICE LEAD PITCH
F	1.7	.067	PAD LENGTH
G	.3	.012	PAD WIDTH
H	.25	.010	GAP
I	3.3	.130	MAX LEAD WIDTH
J	1.0	.039	TYPICAL LEAD WIDTH
J1	1.6	.063	VARIATION LEAD WIDTH
P	3.3	.130	LENGTH FROM SHOULDER $\pm .5\text{mm}$.020in.
S	1.57	.062	PIN SHOULDER HEIGHT
W	.5	.020	PIN WIDTH

TOLERANCES: If not noted are $\pm 20\%$. Nominal values are given. Controlling unit is Millimeters. Slight Variations due to manufacturing process can occur.

BOARD SPECIFICATIONS

BOARD MATERIAL: .8mm, +-.13mm .031in+-.005 in.
Thick G-10 FR-4 Glass Epoxy or equivalent

CIRCUITS: 1 oz. Copper with RoHS compliant Lead Free solder coating. Pattern Position on board +/- .5mm .020in.



A green circular logo with the text "RoHS Compliant" in white.